

LISTING OF THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1-14: (Canceled).

15. (Original) A nonreciprocal circuit device comprising: a dielectric substrate; a magnetic substrate, a space being provided between the magnetic substrate and the dielectric substrate; an electrode provided between said dielectric substrate and said magnetic substrate, the electrode comprising a resonator portion and a transmission line portion; and a magnet applying a dc magnetic field to said electrode; wherein

the transmission line portion of said electrode is relatively near to said dielectric substrate and relatively far from said magnetic substrate, and the resonator portion of said electrode is relatively near to said magnetic substrate and relatively far from said dielectric substrate.

16. (Original) The nonreciprocal circuit device according to Claim 15, wherein the transmission line portion of said electrode is adjacent to or spaced a predetermined distance from said dielectric substrate, and the resonator portion of said electrode is adjacent to or spaced a predetermined distance from said magnetic substrate.

17. (Original) The nonreciprocal circuit device according to Claim 16, wherein a substance having a lower dielectric constant than the dielectric substrate is provided between said dielectric substrate and said resonator portion of said electrode.

18. (Original) The nonreciprocal circuit device according to one of Claims 15, 16 and 17, wherein said electrode is provided by a substrate having an electrode portion on a top face and an electrode portion on a bottom face, the electrode portions being connected by a through hole, said substrate being disposed between said dielectric substrate and said magnetic substrate.

19. (Original) The nonreciprocal circuit device according to one of Claims 15, 16 and 17, wherein the dielectric substrate is provided at least adjacent said transmission line portion of said electrode and is smaller than said magnetic substrate.

20. (Original) The nonreciprocal circuit device according to one of Claims 15, 16 and 17, wherein the magnetic substrate is provided at least adjacent said resonator portion of said electrode and is smaller than said dielectric substrate.

21. (Original) A communications device comprising: the nonreciprocal circuit device according to Claim 15; and one of a transmitting circuit, a receiving circuit, and an antenna connected to said nonreciprocal circuit device.

Claim 22-26: (Canceled).

27. (Original) A method for manufacturing a nonreciprocal circuit device comprising the steps of: providing a dielectric substrate; providing an electrode pattern forming a transmission line portion on said dielectric substrate; providing a magnetic substrate; providing an electrode pattern forming a resonator portion on said magnetic substrate; arranging said dielectric substrate and said magnetic substrate so that their faces provided with said electrode patterns are facing each other, said electrode patterns facing each other at a predetermined connection portion; connecting the electrode pattern of said dielectric substrate to the electrode pattern of said magnetic substrate at said predetermined connection portion; and providing a magnet for applying a dc magnetic field to said electrode patterns.